



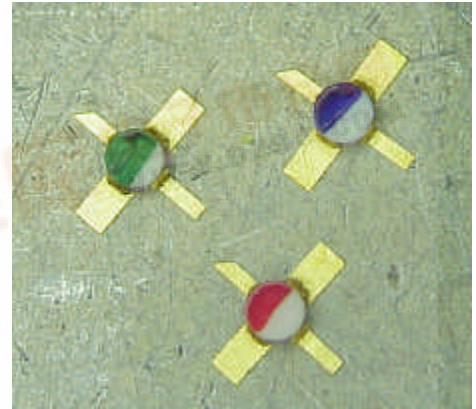
Filtronic

LP7612P70

PACKAGED HIGH DYNAMIC RANGE PHEMT

FEATURES

- ◆ 20 dBm Output Power at 1-dB Compression at 18 GHz
- ◆ 7.5 dB Power Gain at 18 GHz
- ◆ 16 dB Small Signal Gain at 2 GHz
- ◆ 0.8 dB Noise Figure at 2 GHz



DESCRIPTION AND APPLICATIONS

The LP7612P70 is a packaged Aluminum Gallium Arsenide / Indium Gallium Arsenide (AlGaAs/InGaAs) pseudomorphic High Electron Mobility Transistor (pHEMT), utilizing an Electron-Beam direct-write 0.25 μm by 200 μm Schottky barrier gate. The recessed “mushroom” Ti/Pt/Au gate structure minimizes parasitic gate-source and gate resistances. The epitaxial structure and processing have been optimized for high dynamic range. The LP7612’s active areas are passivated with Si_3N_4 , and the P70 ceramic package is ideal for low-cost, high-performance applications that require a surface-mount package.

Typical applications include high dynamic range receiver preamplifiers for commercial applications including Cellular/PCS systems, WLAN and WLL systems, and other types of high-gain applications for radio link systems.

ELECTRICAL SPECIFICATIONS @ $T_{\text{Ambient}} = 25^\circ\text{C}^*$

Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Saturated Drain-Source Current**	I_{DSS}	$V_{\text{DS}} = 2 \text{ V}; V_{\text{GS}} = 0 \text{ V}$	40		85	mA
Power at 1-dB Compression	P-1dB	$V_{\text{DS}} = 5 \text{ V}; I_{\text{DS}} = 50\% I_{\text{DSS}}$	19	20		dBm
Power Gain at 1-dB Compression	G-1dB	$V_{\text{DS}} = 5 \text{ V}; I_{\text{DS}} = 50\% I_{\text{DSS}}$	6.5	7		dB
Power-Added Efficiency	PAE	$V_{\text{DS}} = 5 \text{ V}; I_{\text{DS}} = 50\% I_{\text{DSS}}$		45		%
Noise Figure	NF	$V_{\text{DS}} = 3.3 \text{ V}; I_{\text{DS}} = 25\% I_{\text{DSS}};$ $f=2 \text{ GHz}$		0.8	1.2	dB
Maximum Drain-Source Current	I_{MAX}	$V_{\text{DS}} = 2 \text{ V}; V_{\text{GS}} = 1 \text{ V}$		125		mA
Transconductance	G_{M}	$V_{\text{DS}} = 2 \text{ V}; V_{\text{GS}} = 0 \text{ V}$	60	80		mS
Gate-Source Leakage Current	I_{GSO}	$V_{\text{GS}} = -5 \text{ V}$		1	15	μA
Pinch-Off Voltage	V_{P}	$V_{\text{DS}} = 2 \text{ V}; I_{\text{DS}} = 1 \text{ mA}$	-0.25	-0.8	-1.5	V
Gate-Source Breakdown Voltage Magnitude	$ V_{\text{BDGS}} $	$I_{\text{GS}} = 1 \text{ mA}$	-6	-7		V
Gate-Drain Breakdown Voltage Magnitude	$ V_{\text{BDGD}} $	$I_{\text{GD}} = 1 \text{ mA}$	-8	-9		V

*frequency=18 GHz, unless otherwise noted

**Formerly binned as: LPD7612P70-1 = 40-65 mA and LPD7612P70-2 = 66-85 mA



• ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Test Conditions	Min	Max	Units
Drain-Source Voltage	V_{DS}	$T_{Ambient} = 22 \pm 3^{\circ}C$		6	V
Gate-Source Voltage	V_{GS}	$T_{Ambient} = 22 \pm 3^{\circ}C$		-3	V
Drain-Source Current	I_{DS}	$T_{Ambient} = 22 \pm 3^{\circ}C$		$2 \times I_{DSS}$	mA
Gate Current	I_G	$T_{Ambient} = 22 \pm 3^{\circ}C$		5	mA
RF Input Power	P_{IN}	$T_{Ambient} = 22 \pm 3^{\circ}C$		60	mW
Channel Operating Temperature	T_{CH}	$T_{Ambient} = 22 \pm 3^{\circ}C$		175	$^{\circ}C$
Storage Temperature	T_{STG}	—	-65	175	$^{\circ}C$
Total Power Dissipation	P_{TOT}	$T_{Ambient} = 22 \pm 3^{\circ}C$		400	mW

Notes:

- Operating conditions that exceed the Absolute Maximum Ratings could result in permanent damage to the device.
- Power Dissipation defined as: $P_{TOT} \equiv (P_{DC} + P_{IN}) - P_{OUT}$, where
 P_{DC} : DC Bias Power
 P_{IN} : RF Input Power
 P_{OUT} : RF Output Power
- Absolute Maximum Power Dissipation to be de-rated as follows above $25^{\circ}C$:
 $P_{TOT} = 400mW - (2.7 mW/^{\circ}C) \times T_{HS}$
where T_{HS} = heatsink or ambient temperature.
- This PHEMT is susceptible to damage from Electrostatic Discharge. Proper precautions should be used when handling these devices.

• HANDLING PRECAUTIONS

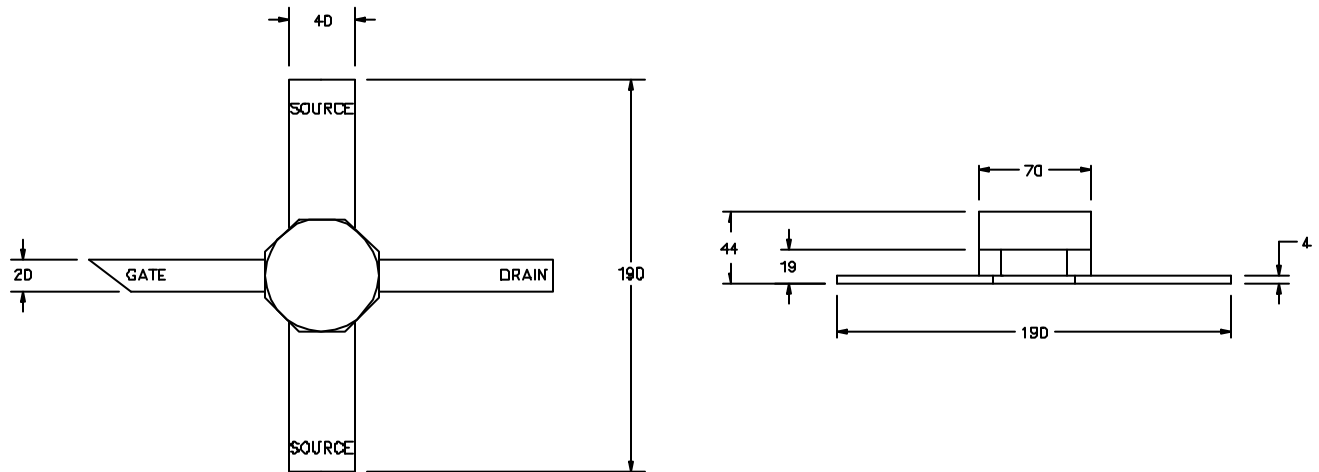
To avoid damage to the devices care should be exercised during handling. Proper Electrostatic Discharge (ESD) precautions should be observed at all stages of storage, handling, assembly, and testing. These devices should be treated as Class 1A (0-500 V). Further information on ESD control measures can be found in MIL-STD-1686 and MIL-HDBK-263.

• APPLICATIONS NOTES & DESIGN DATA

Applications Notes are available from your local Filtronic Sales Representative or directly from the factory. Complete design data, including S-parameters, noise data, and large-signal models are available on the Filtronic web site.

- PACKAGE OUTLINE

(dimensions in mils)



All information and specifications are subject to change without notice.